

# **NOVASTACK® 35-HDH Connector**

Part No. Plug:21003-0\*\*E Receptacle:21004-0\*\*E

# **Product Specification**

Qualification Test Report No. TR-22021

2	S24181	May 16, 2024	Y. Baba	-	S. Suzuki
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Rev.	ECN	Date	Prepared by	Checked by	Approved by
0 (1)			LDEVI		

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### 1. Scope

This Product Specification defines the test conditions and the performances of the NOVASTACK 35-HDH Connector, a board-to-board connector of 0.35 mm contact pitch.

### 2. Product Name and Parts No.

### 2.1 Product Name

**NOVASTACK 35-HDH** 

#### 2.2 Parts No.

Plug: 21003-0\*\*E Receptacle: 21004-0\*\*E

### 3. Rating

### 3.1 Operating Conditions

Amperage: Signal contact ... 0.5A AC/DC (Per Contact Pin) 12.0A MAX. (Total)

Voltage: 60V AC(r.m.s)/DC (per contact pin)

Operating temperature: 233 to 358K(-40°C to +85°C)

(Containing temperature rise by current) Operating humidity: 85%R.H. max.

### 3.2 Storage Conditions

Storage temperature: 248 - 333K(-25 $^{\circ}$ C - +60 $^{\circ}$ C) Storage humidity: 85%R.H. max. (Non-condensing)

### 4. Test and Performance

### **Test Condition**

This initial test is equal to it's at shipping condition and unless otherwise specified, all tests and measurements shall be performed under the following conditions in accordance with MIL-STD-202.

Temperature: 288K to 308K (+15 $^{\circ}$ C to +35 $^{\circ}$ C)

Atmospheric Pressure: 866hPa to 1,066hPa (650mmHg to 800mmHg)

Relative Humidity: 45 to 75%R.H.

### 4.1. Electrical Performance

1. Contact Resistance	
Reference Standard:	MIL-STD-202-307
Test Conditions:  Solder the receptacle connector to the test board and mate the plug connector together, then measure the resistance as shown in Fig. 1 by the four terminal methods. Apply the low level condition of 20mV MAX. I open circuit voltage and 10mA DC for the closed circuit current.	
	Plug Shell (Ground) Plug Side Plug Contact Courted to the contact of the contact
	Receptacle Shell (Ground)  PCB  Receptacle Side  Receptacle Side
	Fig.1
Pass Criteria:	Contact Initial: $50 \text{ m}\Omega$ max. After testing: $\angle$ R $50 \text{ m}\Omega$ max. Ground
	Initial: $20 \text{ m}\Omega$ max. After testing: $\angle$ R $20 \text{ m}\Omega$ max.

2. Insulation Resistance	
Reference Standard:	MIL-STD-202-302
Test Conditions:	Mate the plug and receptacle connector together, and then apply DC 250 V between the neighboring contacts and contact to the shell.
Pass Criteria:	Initial: 1,000 MΩ min. After testing: 500 MΩ min.

3. Dielectric withstanding voltage		
Reference standard:	MIL-STD-202-301	
Test conditions:	Mate the receptacle and plug connector together, then apply AC 250V(rms) between the neighboring contacts and contact to the shell for a minute.	
Pass criteria:	No abnormalities such as creeping discharge, flashover, insulator breakdown occur.	

4. Temperature rising	
Reference standard:	•
Test conditions:	Mate the plug and receptacle connector together and then apply rating current per contact.
	Contact • • • 0.5A/pin.
	Total ••• 12A MAX.
Pass criteria:	Over ambient ∠T30 °C max.

## 4.2. Mechanical Performance

1. Mating force and Unmating force		
Reference standard:	-	
Test conditions:	Solder the plug and receptacle connector to the test board, then place the plug and receptacle on push-on/pull-off machine, measure of initial and mating/unmating 20 cycles at a speed 25±3 mm/min. along the mating axis.	
Pass criteria:	Mating force 60P: Initial 60 N MAX. 70P: Initial 70 N MAX. Unmating force 60P: 20cycle 6.0 N MIN. 70P: 20cycle 7.0 N MIN.	

2.Durability	
Reference standard:	-
Test conditions:	Solder the plug and receptacle connector to the test board, then place the board and plug on the push-on/pull-off machine, and repeat mating and unmating 20 cycles at a speed 25±3 mm/min. along the mating axis.
Pass criteria:	Contact resistance: Shall meet4.1.1

3.Contact retention force	
Reference standard:	-
Test conditions:	Place the connector on the push-on/pull-off machine, then apply force on the contact head and push the contact along the direction opposite to the contact insertion at a speed of 25±3mm/min. Measure the force when the contact dislodges the connector.
Pass criteria:	Receptacle contact retention force: 0.1N MIN.

4. Vibration	
Reference standard:	MIL-STD-202-201
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug connector, and place them on the vibrator. Then apply the following vibration. During the testing, run 100mA DC to check electrical discontinuity. Frequency: 10Hz→55Hz→10Hz/approx. 1 minute Directions: 3 mutually perpendicular direction.  Total Amplitude: 1.52 mm  Sweep duration: 2 hours for each direction, a total of 6 hours.
Pass criteria:	Contact resistance: Shall meet 4.1.1.  Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.  Appearance: No abnormality adversely affecting the performance shall occur.

5. Shock			
Reference standard:	MIL-STD-202-213, Test condition A.		
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug connector, and place them on the shock machine. Then apply the following shock.		
	Max. G: 50G	Directions: 6 mutually perpendicular direction	
	Duration: 11 msec	Cycle: 3 cycles about each direction	
	Wave Form: Half Sinusoidal		
Pass criteria:	Contact resistance: Shall meet 4.1.1.		
	Electrical discontinuity: No electrical discontinuity greater than 1µs shall occur.		
	Appearance: No abnormality adversely affecting the performance shall occur.		

### 4.3. Environmental Performance

Thermal shock	
Reference standard:	MIL-STD-202-107, Test condition A.
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose them to the following environment.
	Temperature: 218K (-55°C), 30 minutes→358K (85°C), 30 minutes
	Transition time: 5 minutes max.

No. of cycles: 5 cycles Refer to Fig. 2 for sequence.

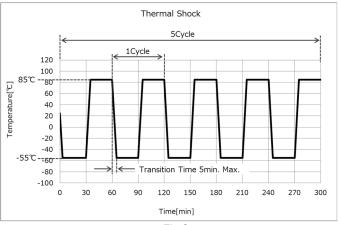


Fig.2

Pass criteria: Contact resistance: Shall meet 4.1.1.
Insulation resistance: Shall meet 4.1.2.

Dielectric withstanding voltage: Shall meet 4.1.3.

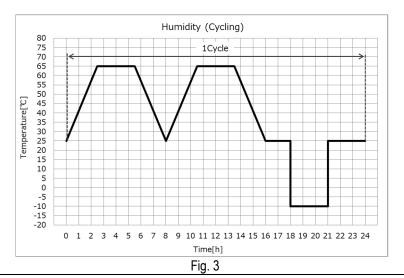
Appearance: No abnormality adversely affecting the performance shall occur.

2. High temperature life	
Reference standard:	MIL-STD-202-108, Test condition B.
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose them to the following environment.  Temperature: 358±2K (85±2°C)  Duration: 250 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1. Contact retention force: Shall meet 4.2.3. Appearance: No abnormality adversely affecting the performance shall occur.

### 4.3. Environmental Performance

3. Humidity (Steady state)								
Reference standard:	erence standard: MIL-STD-202-103, Test condition A.							
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose them to the following environment.  Temperature: 313±2K (40±2°C)							
	Humidity: 90 to 95%RH Duration: 240 hours							
Pass criteria:	Contact resistance: Shall meet 4.1.1. Insulation resistance: Shall meet 4.1.2. Dielectric withstanding voltage: Shall meet 4.1.3. Appearance: No abnormality adversely affecting the performance shall occur.							

4. Humidity (Cycling)	
Reference standard:	MIL-STD-202-106.
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose them to the following environment.  Temperature: 298[263] to 338K (25[-10] to 65°C)  Humidity: 90 to 98%RH  Duration: 10 cycles (240 hours)  Refer to Fig. 3 for sequence.



Pass criteria:

Contact resistance: Shall meet 4.1.1.

Insulation resistance: Shall meet 4.1.2.

Dielectric withstanding voltage: Shall meet 4.1.3.

Appearance: No abnormality adversely affecting the performance shall occur.

### 4.3. Environmental Performance

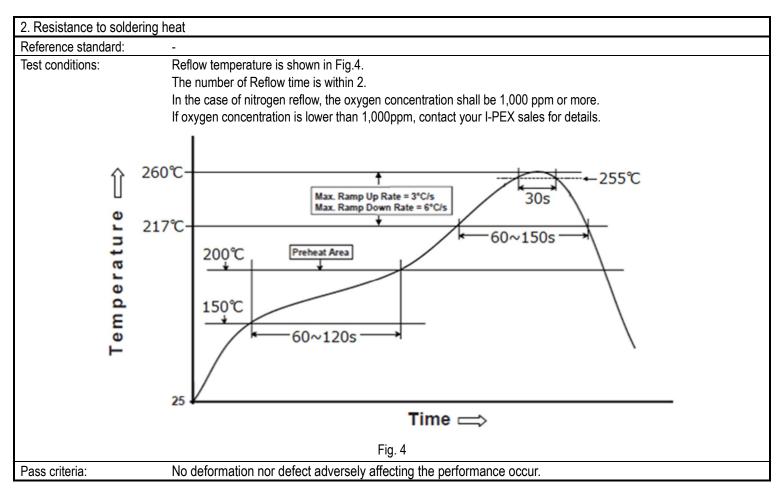
5. Salt spray							
Reference standard: MIL-STD-202-101, Test condition B.							
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose						
	them to the following environment.						
	Temperature: 308±2K (35±2°C)						
	Salt water density: 5±1% [by weight]						
	Duration: 48 hours						
Pass criteria:	Contact resistance: Shall meet 4.1.1.						
	Appearance: No abnormality adversely affecting the performance shall occur.						

6. H₂S gas	
Reference standard:	-
Test conditions:	Solder the plug and receptacle connector to the test board, then mate plug and receptacle connector, and expose them to the following environment.  Temperature: 313±2K (40±2°C)  Relative humidity: 80±5%RH  Gas: H2S 3±1ppm  Duration: 48 hours
Pass criteria:	Contact resistance: Shall meet 4.1.1.  Appearance: No abnormality adversely affecting the performance shall occur.

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### 4.4. Others

1. Solderability					
Reference standard: MIL-STD-202G-208H					
Test conditions:	Dip the solder tine of the contact in the solder bath at 518±5K (245±5°C) for				
	5±0.5 seconds after immersing the tine in the flux of RMA or R type for 5 to 10 seconds.				
Pass criteria:	More than 95% of the dipped surface shall be evenly wet.				



3. Soldering Iron					
Reference standard:	•				
Test conditions:	Operating temperature : 613 to 633K (350°C±10)				
	Application time of soldering iron : 5±1sec.				
	The number of times of application : 3times				
Pass criteria:	No deformation nor defect adversely affecting the performance occur.				

### 4.5 Test Sequence and Specimen Quantity

**Table 1 Test Sequence and Sample Quantity** 

Table 1 Test Sequence and Sample Quantity															
No.		Test Item	Testing Groups												
		rest item	Α	В	С	D	Е	F	G	Н	J	K	L	М	N
4.1 Electrical Performance	1	Contact resistance		2,6		1,3,5	1,5	1,3	1,5	1,5	1,3	1,3			
	2	Insulation resistance					2,6		2,6	2,6					
	3	Dielectric withstanding voltage					3,7		3,7	3,7					
	4	Temperature rising	1												
4.2 Mechanical Performance	1	Mating force		1,5											
		Unmating force		3,7											
	2	Durability		4											
	3	Contact retention force			1										
	4	Vibration				2									
	5	Shock				4									
	1	Thermal shock					4								
intal e	2	High temperature life						2							
4.3 Environmental Performance	3	Humidity (Steady State)							4						
	4	Humidity (Cycling)								4					
	5	Saltwater spray									2				
	6	H₂S gas										2			
SJE	1	Solder ability											1		
4.4 Others	2	Soldering heat resistance												1	
	3	Soldering iron													1
Specimen quantity		5	5	20	5	5	5	5	5	5	5	10	10	10	
		pcs.	pcs.	pcs.	pcs.	pcs.	pcs.	pcs.	pcs.	pcs.	pcs.	pcs.	pcs.	pcs.	

<sup>\*\*</sup>Numbers indicate sequence in which tests are performed.

### 5. Recommended Metal Mask

Refer to drawing for the recommended metal mask thickness and opening dimension.